XC6201 Series

Positive Voltage Regulators

■GENERAL DESCRIPTION

The XC6201 series are highly precise, low power consumption, positive voltage regulators manufactured using CMOS and laser trimming technologies.

The series provides large currents with a significantly small dropout voltage.

The XC6201 consists of a current limiter circuit, a driver transistor, a precision reference voltage and an error amplifier. Output voltage is selectable in 0.1V steps between 1.3V ~ 6.0V.

SOT-25, SOT-89 and USP-6B packages are available.

■APPLICATIONS

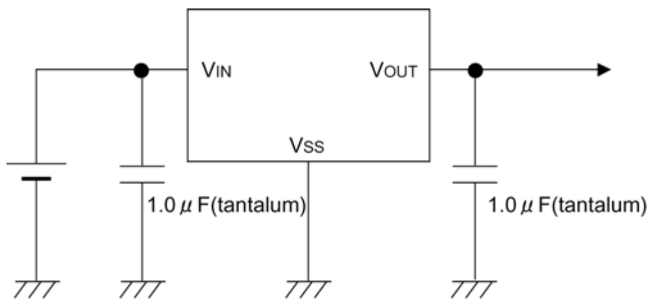
- Smart phones / Mobile phones
- Portable game consoles
- Digital still cameras / Camcorders
- Digital audio equipment
- Reference voltage sources
- Multi-function power supplies

■FEATURES

Maximum Output Current	: 250mA (TYP.)
Dropout Voltage	: 0.16V @ 100mA
	: 0.40V @ 200mA
Maximum Operating Voltage	: 10V
Output Voltage Range	: 1.3V ~ 6.0V (0.1V increments)
Fixed Voltage Accuracy	: ±1% ($V_{OUT(T)} \geq 2.0V$)
	±2%
Low Power Consumption	: 2.0 μA (TYP.)
Operating Ambient Temperature	: -40℃ ~ 85℃
Packages	: SOT-25,
	SOT-89
	USP-6B
Environmentally Friendly	: EU RoHS Compliant, Pb Free

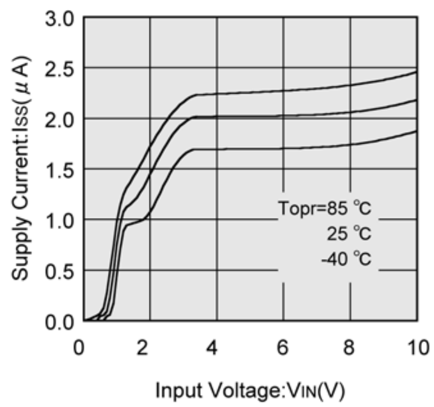
Tantalum or Ceramic Capacitor compatible

■TYPICAL APPLICATION CIRCUIT

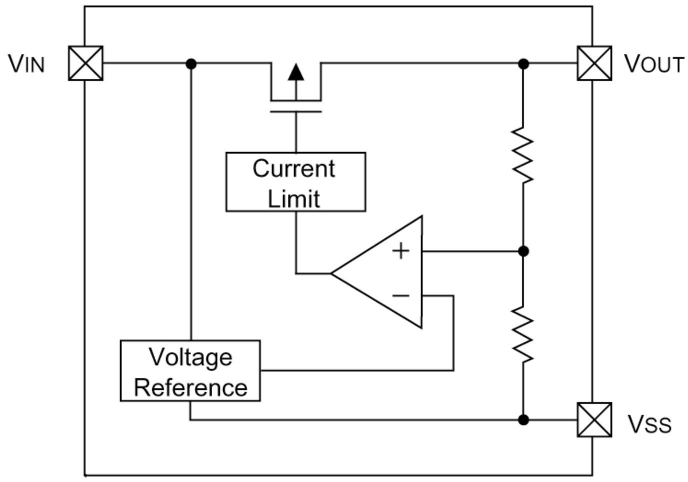


■TYPICAL PERFORMANCE CHARACTERISTICS

●Supply Current vs. Input Voltage



■BLOCK DIAGRAM



■PRODUCT CLASSIFICATION

●Ordering Information

X C 6 2 0 1 P ③④⑤⑥⑦-⑧(*1)

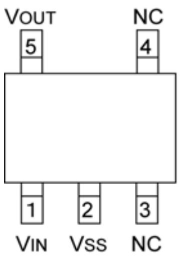
① ②

DESIGNATOR	ITEM	SYMBOL	DESCRIPTION
①	Product Number	01	-
②	Type of Regulator	P	3-pin regulator
③④	Output Voltage	13～60	e.g. 30:3.0V 50:5.0V
⑤	Output Voltage Accuracy	1	±1%
		2	±2%
⑥⑦-⑧	Packages (Order Unit)	MR	SOT-25 (3,000pcs/Reel)
		MR-G	SOT-25 (3,000pcs/Reel)
		PR	SOT-89 (1,000pcs/Reel)
		PR-G	SOT-89 (1,000pcs/Reel)
		DR	USP-6B (3,000pcs/Reel)
		DR-G	USP-6B (3,000pcs/Reel)

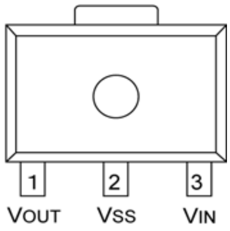
(*1) The "-G" suffix denotes Halogen and Antimony free as well as being fully EU RoHS compliant.

* ±1% accuracy can be set at $V_{OUT(T)} \geqq 2.0V$.

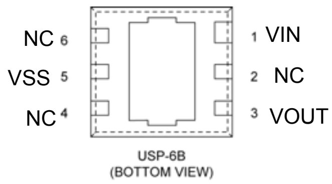
■PIN CONFIGURATION



SOT-25
(TOP VIEW)



SOT-89
(TOP VIEW)



*The dissipation pad for the USP-6B package should be solder-plated in recommended mount pattern and metal masking so as to enhance mounting strength and heat release.
If the pad needs to be connected to other pins, it should be connected to the VSS (No.5) pin.

■PIN ASSIGNMENT

PIN NUMBER			PIN NAME	FUNCTION
SOT-25	SOT-89	USP-6B		
5	1	3	VOUT	Output
2	2	5	VSS	Ground
1	3	1	VIN	Power Input
3, 4	—	2,4,6	NC	No Connection

■ABSOLUTE MAXIMUM RATINGS

Ta = 25℃

PARAMETER		SYMBOL	RATINGS	UNITS
Input Voltage		VIN	12.0	V
Output Current		IOUT	500	mA
Output Voltage		VOUT	VSS-0.3～VIN+0.3	V
Power Dissipation	SOT-25	Pd	250	mW
	SOT-89		500	
	USP-6B		120	
Operating Temperature		Topr	-40～+85	℃
Storage Temperature		Tstg	-55～+125	℃

■ELECTRICAL CHARACTERISTICS

XC6201P132 $V_{OUT(T)}$=1.3V (*1) Ta=25℃

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS	CIRCUIT
Output Voltage	$V_{OUT(E)}$ (*2)	V_{IN}=2.3V I_{OUT}=10mA	1.274	1.300	1.326	V	②
Maximum Output Current	I_{OUTmax}	V_{IN}=2.3V $V_{OUT(E)}$≧1.17V	60	-	-	mA	②
Load Regulation	ΔV_{OUT}	V_{IN}=2.3V 1mA≦I_{OUT}≦30mA	-	10	30	mV	②
Dropout Voltage (*3)	Vdif1	I_{OUT}=30mA	-	200	600	mV	②
Dropout Voltage (*3)	Vdif2	I_{OUT}=60mA	-	500	810	mV	②
Supply Current	I_{SS}	V_{IN}=2.3V	-	2.0	5.0	μA	①
Line Regulation	$\frac{\Delta V_{OUT}}{\Delta V_{IN} \cdot \Delta V_{OUT}}$	I_{OUT}=10mA 2.3V≦V_{IN}≦10.0V	-	0.2	0.3	%/V	②
Input Voltage	V_{IN}		1.8	-	10	V	-
Output Voltage Temperature Characteristics	$\frac{\Delta V_{OUT}}{\Delta Topr \cdot \Delta V_{OUT}}$	I_{OUT}=40mA -40℃≦Topr≦85℃	-	±100	-	ppm/℃	②

XC6201P182 $V_{OUT(T)}$=1.8V (*1) Ta=25℃

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS	CIRCUIT
Output Voltage	$V_{OUT(E)}$ (*2)	V_{IN}=2.8V IOUT=40mA	1.764	1.800	1.836	V	②
Maximum Output Current	I_{OUTmax}	V_{IN}=2.8V $V_{OUT(E)}$≧1.62V	80	-	-	mA	②
Load Regulation	ΔV_{OUT}	V_{IN}=2.8V 1mA≦I_{OUT}≦40mA	-	10	30	mV	②
Dropout Voltage (*3)	Vdif1	I_{OUT}=40mA	-	200	370	mV	②
Dropout Voltage (*3)	Vdif2	I_{OUT}=80mA	-	450	710	mV	②
Supply Current	I_{SS}	V_{IN}=2.8V	-	2.0	5.0	μA	①
Line Regulation	$\frac{\Delta V_{OUT}}{\Delta V_{IN} \cdot \Delta V_{OUT}}$	I_{OUT}=40mA 2.8V≦V_{IN}≦10.0V	-	0.2	0.3	%/V	②
Input Voltage	VIN		1.8	-	10	V	-
Output Voltage Temperature Characteristics	$\frac{\Delta V_{OUT}}{\Delta Topr \cdot \Delta V_{OUT}}$	I_{OUT}=40mA -40℃≦Topr≦85℃	-	±100	-	ppm/℃	②

XC6201P272 $V_{OUT(T)}$=2.7V (*1) Ta=25℃

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS	CIRCUIT
Output Voltage	$V_{OUT(E)}$ (*2)	V_{IN}=3.7V I_{OUT}=40mA	2.646	2.700	2.754	V	②
Maximum Output Current	I_{OUTmax}	V_{IN}=3.7V $V_{OUT(E)}$≧2.43V	100	-	-	mA	②
Load Regulation	ΔV_{OUT}	V_{IN}=3.7V 1mA≦I_{OUT}≦60mA	-	15	40	mV	②
Dropout Voltage (*3)	Vdif1	I_{OUT}=60mA	-	200	370	mV	②
Dropout Voltage (*3)	Vdif2	I_{OUT}=120mA	-	450	710	mV	②
Supply Current	I_{SS}	V_{IN}=3.7V	-	2.0	5.0	μA	①
Line Regulation	$\frac{\Delta V_{OUT}}{\Delta V_{IN} \cdot \Delta V_{OUT}}$	I_{OUT}=40mA 3.7V≦V_{IN}≦10.0V	-	0.2	0.3	%/V	②
Input Voltage	V_{IN}		1.8	-	10	V	-
Output Voltage Temperature Characteristics	$\frac{\Delta V_{OUT}}{\Delta Topr \cdot \Delta V_{OUT}}$	I_{OUT}=40mA -40℃≦Topr≦85℃	-	±100	-	ppm/℃	②

■ELECTRICAL CHARACTERISTICS (Continued)

XC6201P332 $V_{OUT(T)}$=3.3V (*1) Ta=25℃

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS	CIRCUIT
Output Voltage	$V_{OUT(E)}$ (*2)	V_{IN}=4.3V I_{OUT}=40mA	3.234	3.300	3.366	V	②
Maximum Output Current	I_{OUTmax}	V_{IN}=4.3V $V_{OUT(E)}$≧2.97V	150	-	-	mA	②
Load Regulation	△V_{OUT}	V_{IN}=4.3V 1mA≦I_{OUT}≦80mA	-	20	50	mV	②
Dropout Voltage (*3)	Vdif1	I_{OUT}=80mA	-	200	360	mV	②
	Vdif2	I_{OUT}=160mA	-	450	700		
Supply Current	I_{SS}	V_{IN}=4.3V	-	2.0	5.0	μA	①
Line Regulation	△V_{OUT} / △V_{IN}・△V_{OUT}	I_{OUT}=40mA 4.3V≦V_{IN}≦10.0V	-	0.2	0.3	%/V	②
Input Voltage	V_{IN}		1.8	-	10	V	-
Output Voltage Temperature Characteristics	△V_{OUT} / △Topr・△V_{OUT}	I_{OUT}=40mA -40℃≦Topr≦85℃	-	±100	-	ppm/℃	②

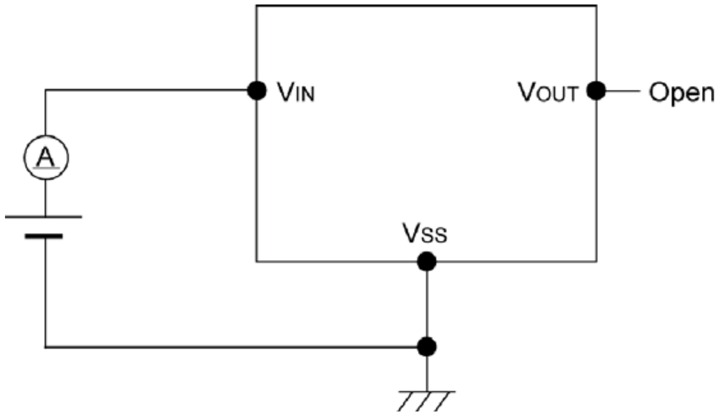
XC6201P502 $V_{OUT(T)}$=5.0V (*1) Ta=25℃

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS	CIRCUIT
Output Voltage	$V_{OUT(E)}$ (*2)	V_{IN}=6.0V I_{OUT}=40mA	4.900	5.000	5.100	V	②
Maximum Output Current	I_{OUTmax}	V_{IN}=6.0V $V_{OUT(E)}$≧4.57V	200	-	-	mA	②
Load Regulation	△V_{OUT}	V_{IN}=6.0V 1mA≦I_{OUT}≦100mA	-	30	70	mV	②
Dropout Voltage (*3)	Vdif1	I_{OUT}=100mA	-	160	340	mV	②
	Vdif2	I_{OUT}=200mA	-	400	600		
Supply Current	I_{SS}	V_{IN}=6.0V	-	2.0	6.0	μA	①
Line Regulation	△V_{OUT} / △V_{IN}・△V_{OUT}	I_{OUT}=40mA 6.0V≦V_{IN}≦10.0V	-	0.2	0.3	%/V	②
Input Voltage	V_{IN}		1.8	-	10	V	-
Output Voltage Temperature Characteristics	△V_{OUT} / △Topr・△V_{OUT}	I_{OUT}=40mA -40℃≦Topr≦85℃	-	±100	-	ppm/℃	②

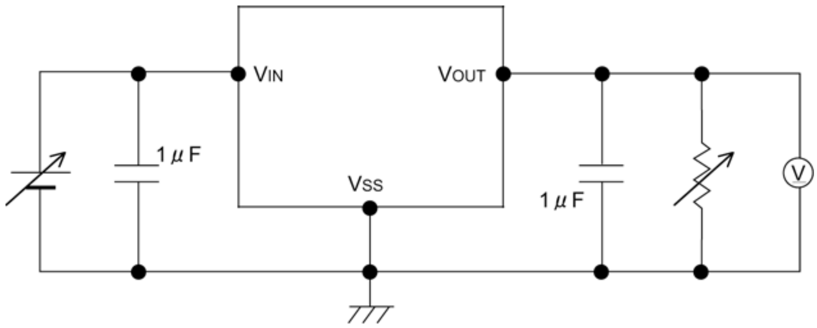
NOTE:
∗1: $V_{OUT(T)}$ = Nominal output voltage.
∗2: $V_{OUT(E)}$ = Effective output voltage (i.e. the output voltage when "$V_{OUT(T)}$+1.0V" is provided while maintaining a certain I_{OUT} value).
∗3: Vdif = (V_{IN1}- V_{OUT1})
VIN1 :An Input Voltage when V_{OUT1} appears as the input voltage is gradually decreased.
V_{OUT1} : A voltage equal to 98% of the output voltage when a stabilized ($V_{OUT(T)}$ + 1.0V) is input.

■TEST CIRCUITS

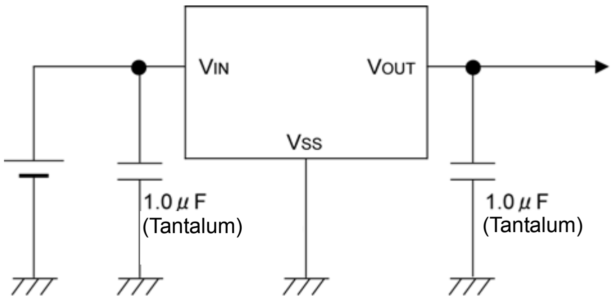
Circuit ① : Supply Current



Circuit ② : Output Voltage, Oscillation, Line Regulation, Dropout Voltage, Load Regulation

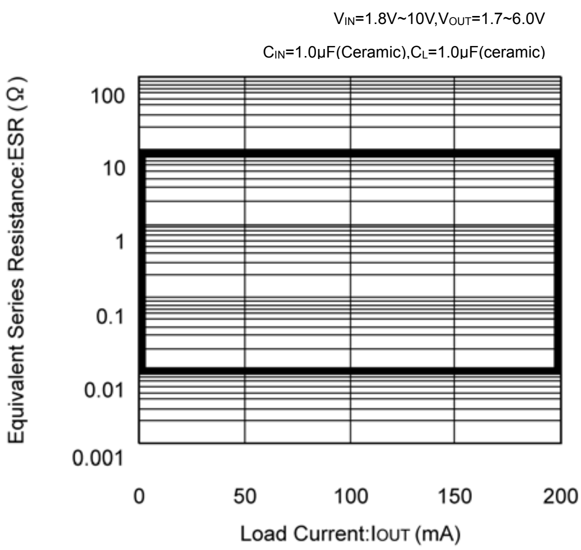


■OPERATIONAL EXPLANATION



With the XC6201 series regulator, in order to ensure the stabilized output voltage, we suggest that an output capacitor (C_L) of 1μF or more be connected between the output pin (V_{OUT}) and the V_{SS} pin. For using low ESR capacitor (e.g. ceramic capacitors), please make sure that the output voltage is more than 1.7V. When the output voltage is from 1.3V to 1.6V, the output capacitor should be a tantalum capacitor with a capacitance of 2.2μF. We also suggest an input capacitor (C_{IN}) should be connected between the V_{IN} and the V_{SS} in order to stabilize input power source.

OUTPUT VOLTAGE	CIN	CL (TANTALUM)	CL (LOW ESR)
1.3V～1.6V	≧1.0μF	≧2.2μF	―
1.7V～6.0V	≧1.0μF	≧1.0μF	≧1.0μF



■ NOTE ON USE

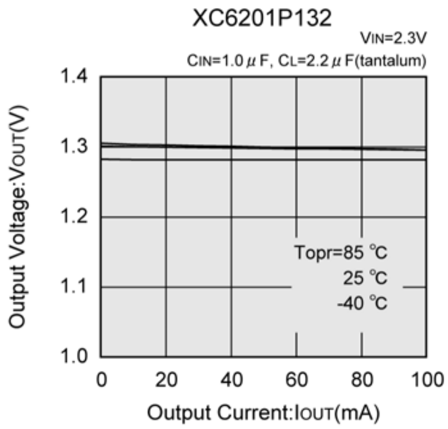
1. Please use this IC within the stated absolute maximum ratings. The IC is liable to malfunction should the ratings be exceeded. When a voltage higher than the V_{IN} flows to the V_{OUT} like when using two power supplies, please connect a Schottky barrier diode between the V_{OUT} and the V_{IN} and do not exceed the V_{OUT} rating.

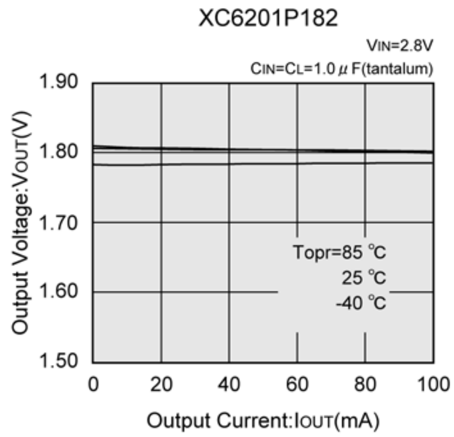
2. An oscillation may occur by the impedance between a power supply and the input of the IC. Where the impedance is 10Ω or more, please use an input capacitor (C_{IN}) of at least 1μF. In case of high output current, operation can be stabilized by increasing the input capacitor value. Also an oscillation may occur if the input capacitor value is smaller than the input impedance when the output capacitance (C_L) is large. In such cases, operations can be stabilized by either increasing the input capacitor value or reducing the output capacitor value.

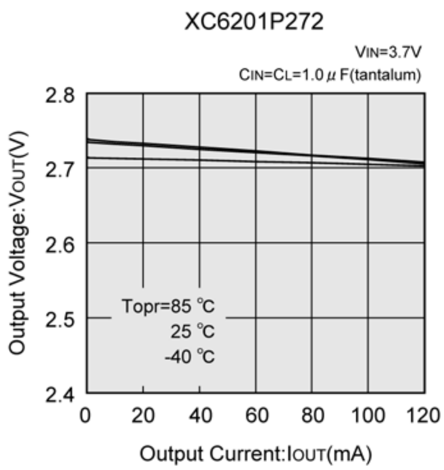
3. Please ensure that output current (I_{OUT}) is less than Pd / (V_{IN} - V_{OUT}) and do not exceed the rated power dissipation value (Pd) of the package.

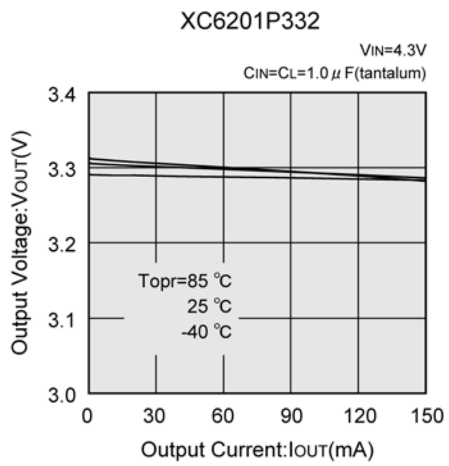
■TYPICAL PERFORMANCE CHARACTERISTICS

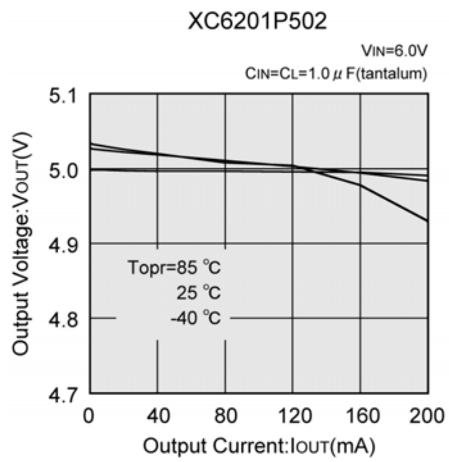
(1) Output Voltage vs. Output Current





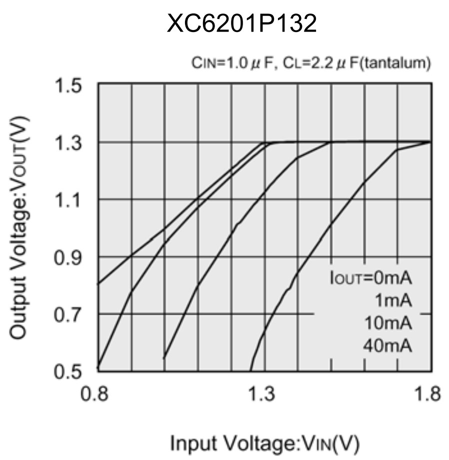


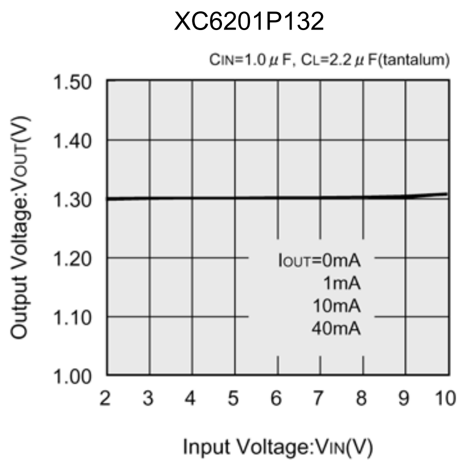


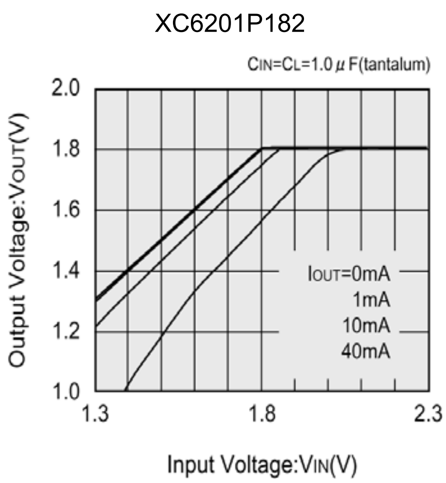


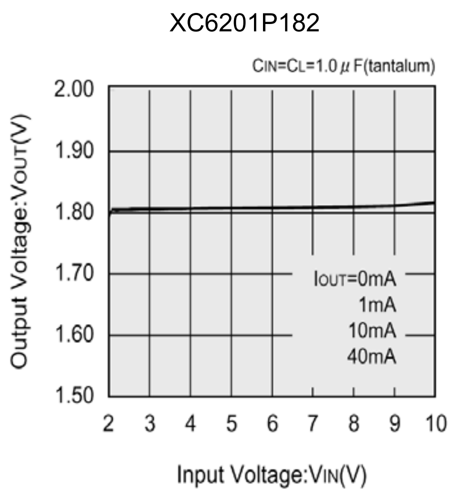
■TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

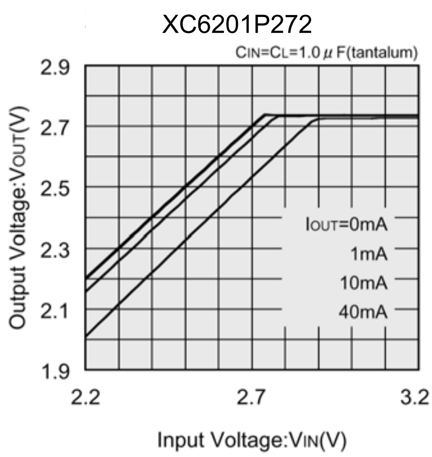
(2) Output Voltage vs. Input Voltage

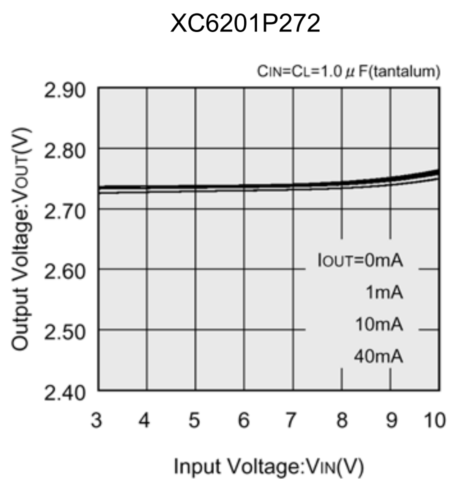








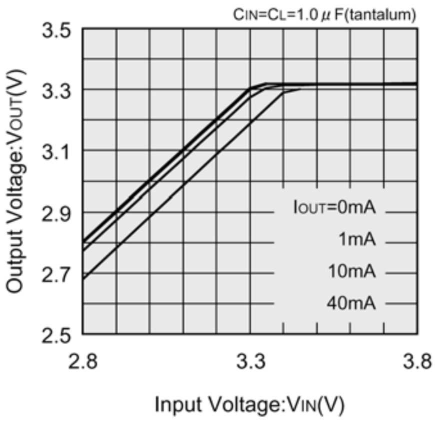




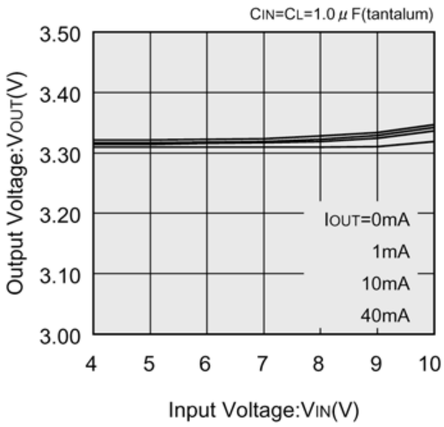
■TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(2) Output Voltage vs. Input Voltage (Continued)

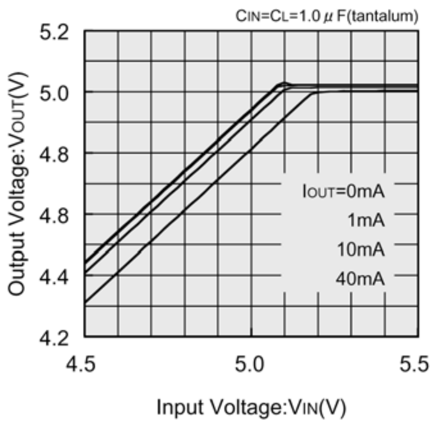
XC6201P332



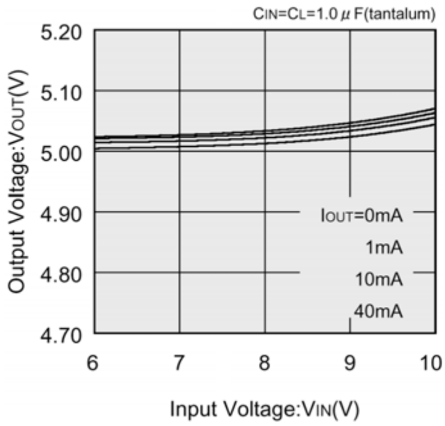
XC6201P332



XC6201P502



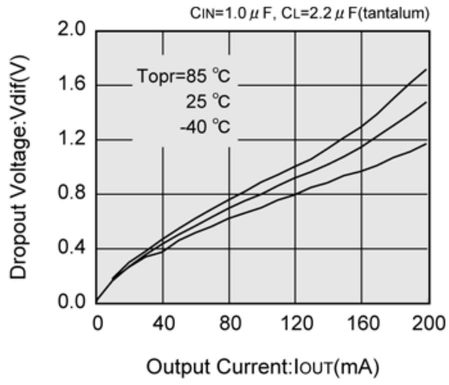
XC6201P502



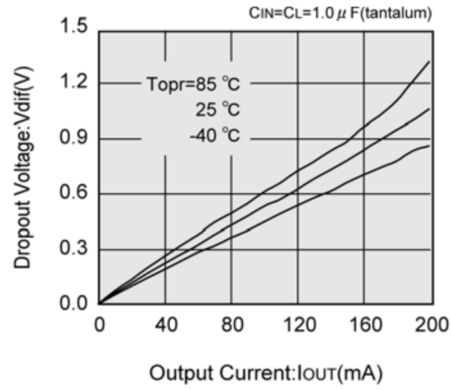
■TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(3) Dropout Voltage vs. Output Current

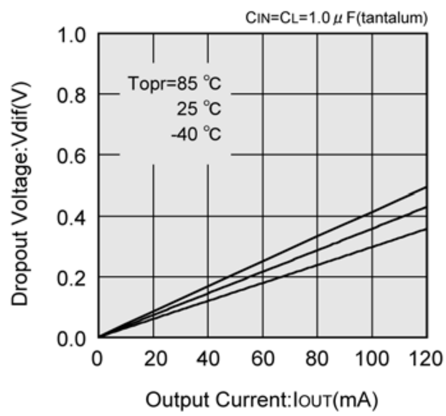
XC6201P132



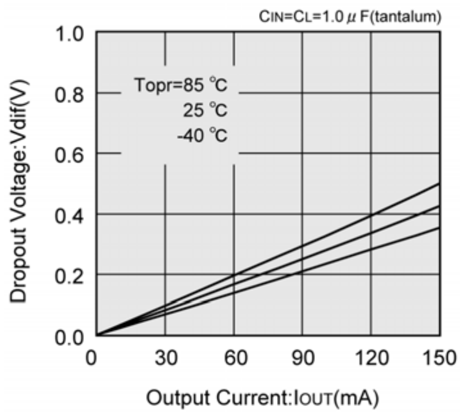
XC6201P182



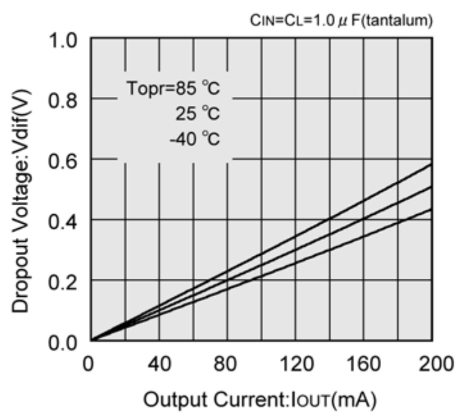
XC6201P272



XC6201P332

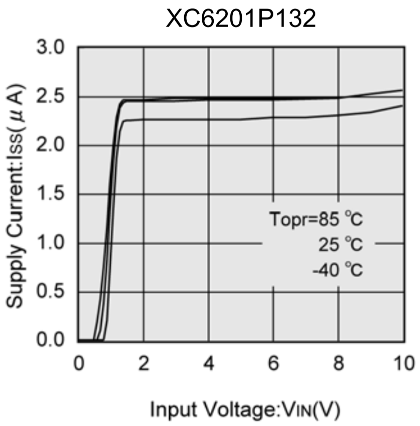


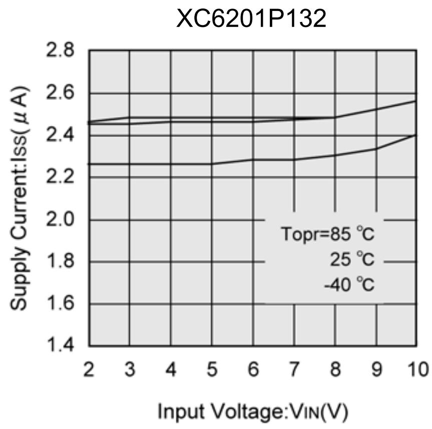
XC6201P502

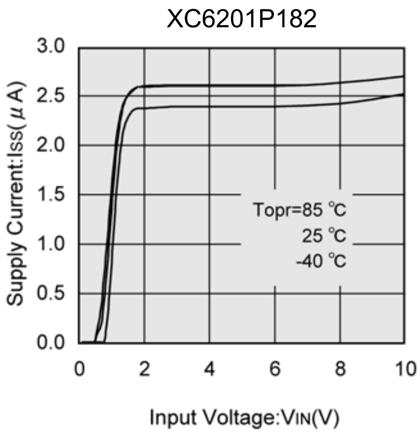


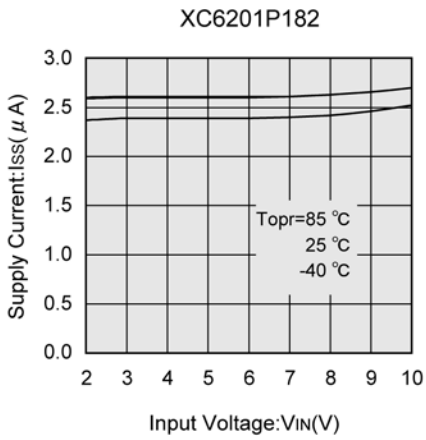
■TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

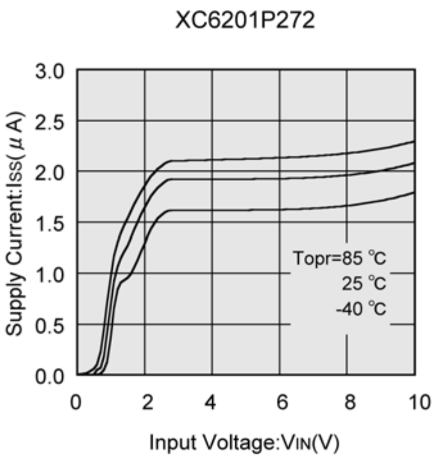
(4) Supply Current vs. Input Voltage

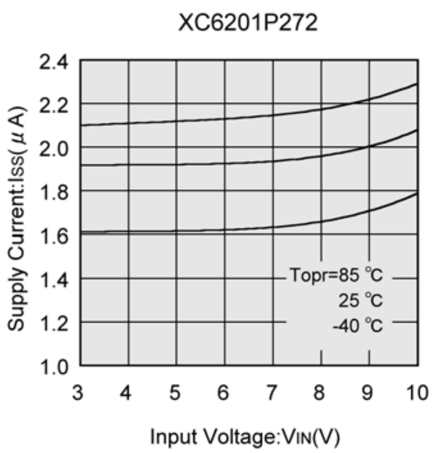






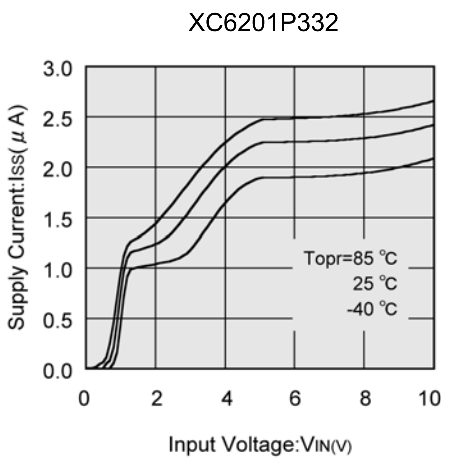


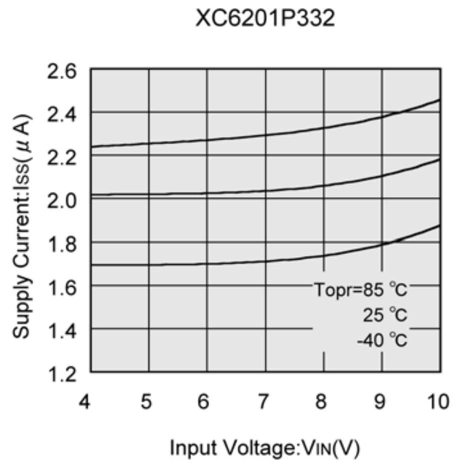


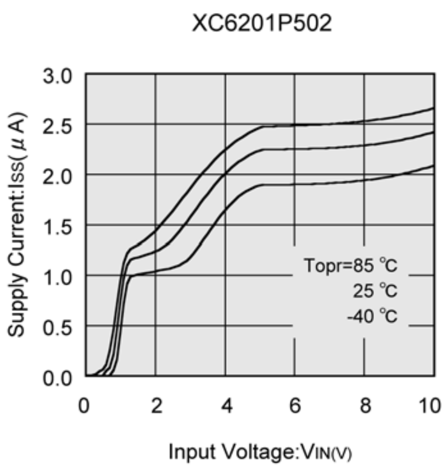


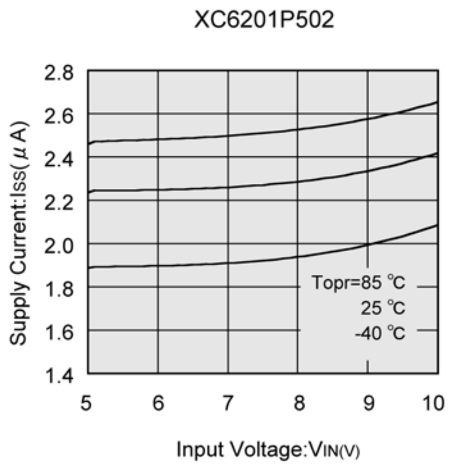
■TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(4) Supply Current vs. Input Voltage (Continued)





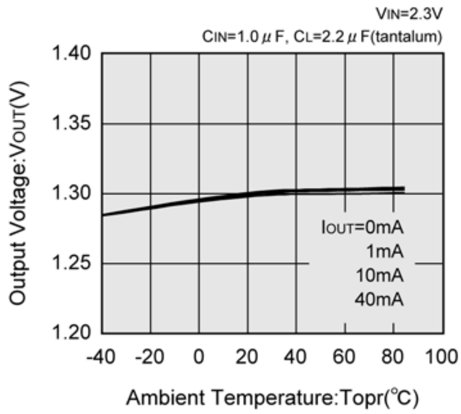




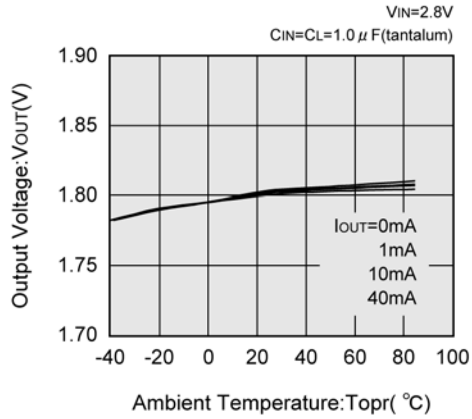
■TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(5) Output Voltage vs. Ambient Temperature

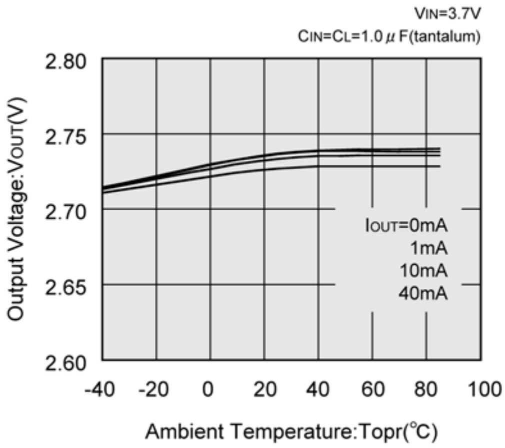
XC6201P132



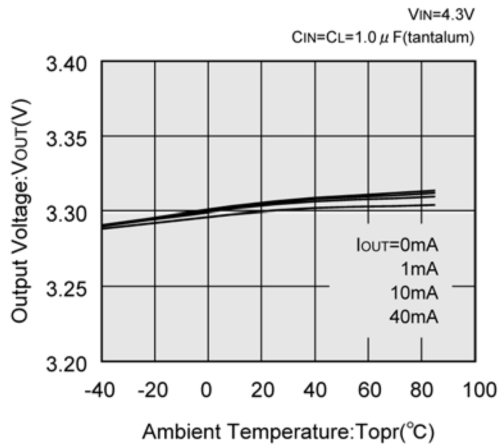
XC6201P182



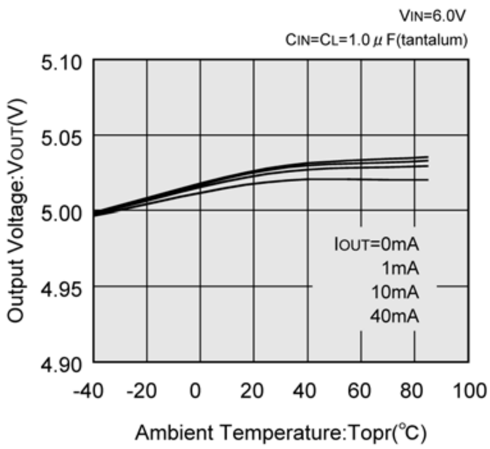
XC6201P272



XC6201P332



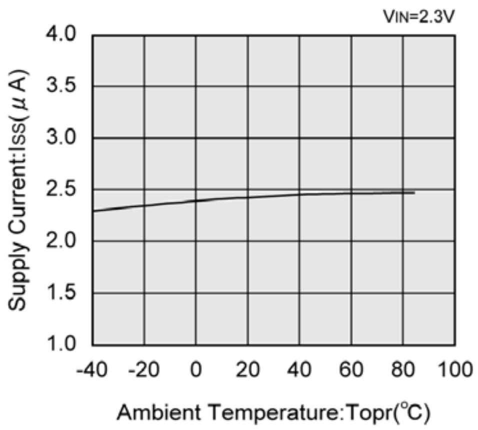
XC6201P502



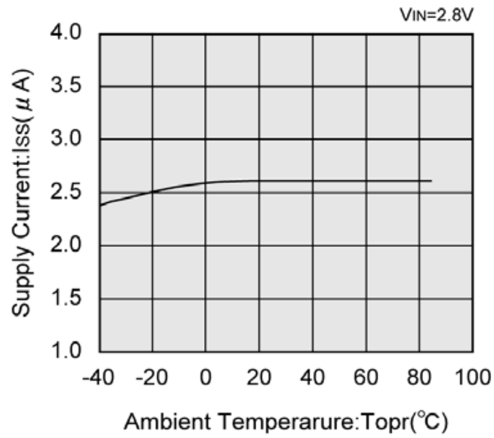
■TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(6) Supply Current vs. Ambient Temperature

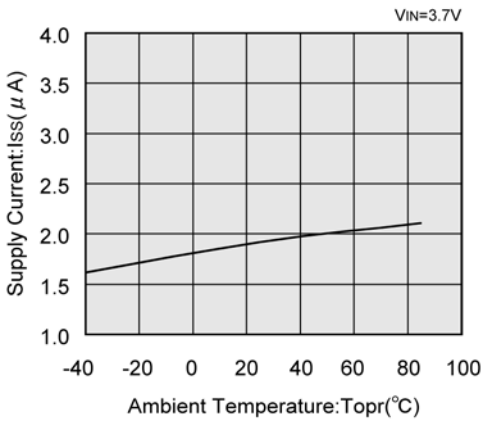
XC6201P132



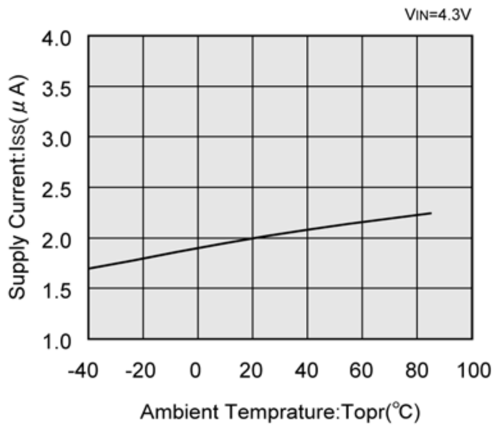
XC6201P182



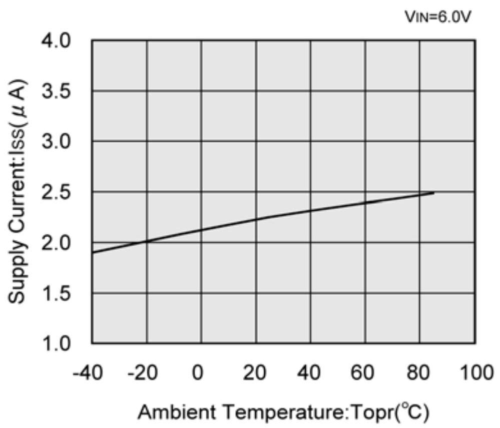
XC6201P272



XC6201P332



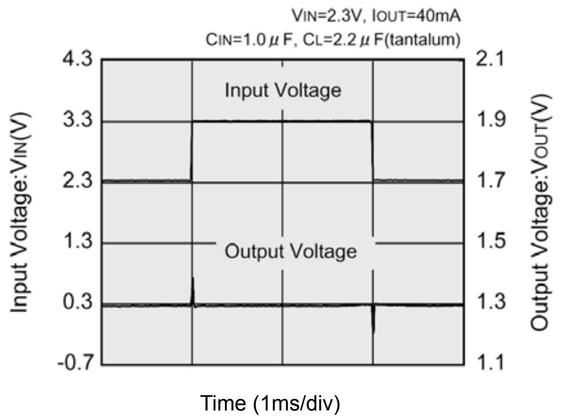
XC6201P502



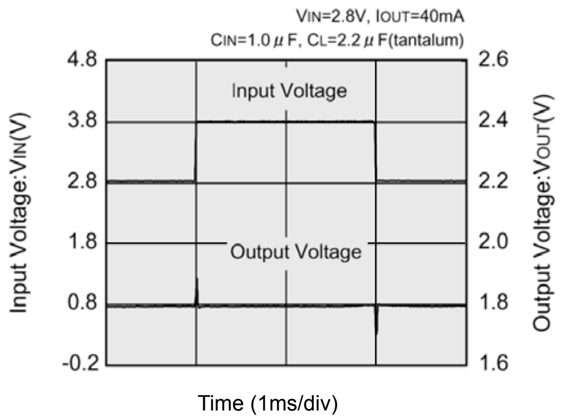
■TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(7) Input Transient Response

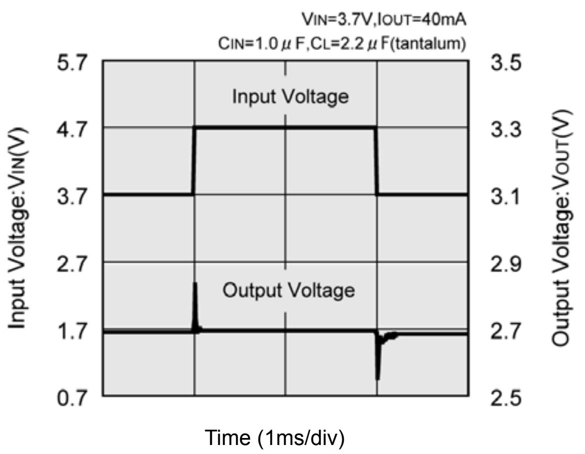
XC6201P132



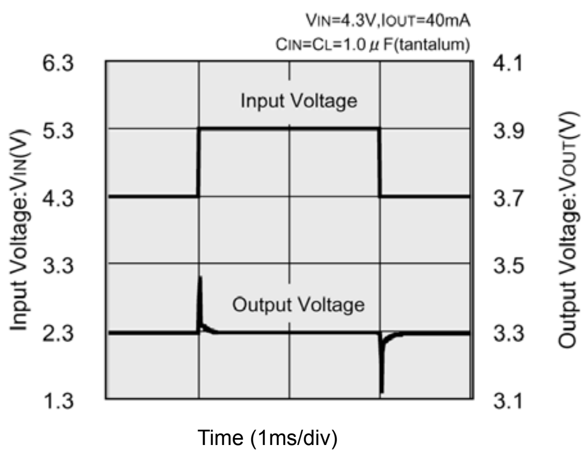
XC6201P182



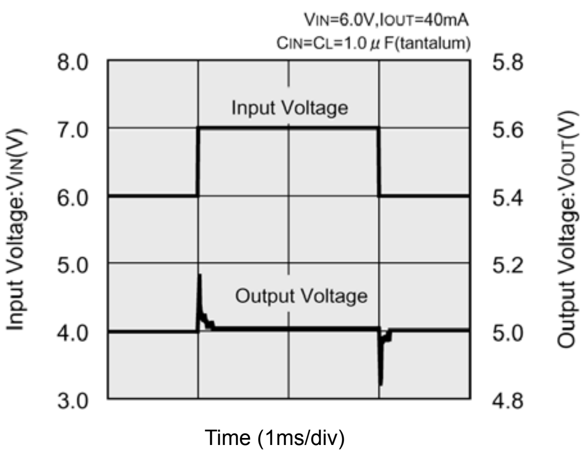
XC6201P272



XC6201P332



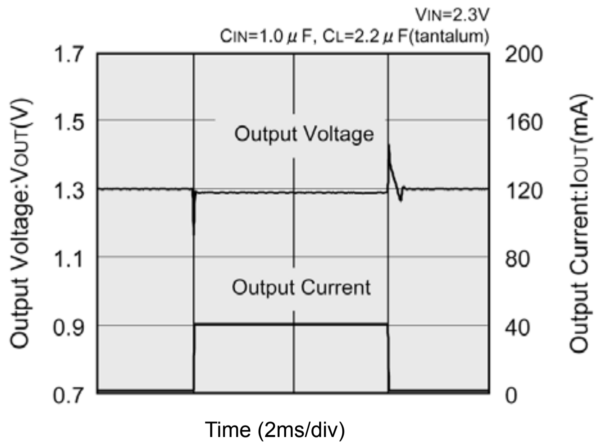
XC6201P502



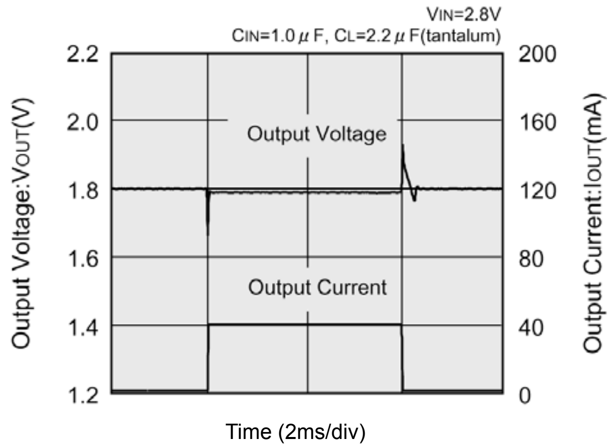
■TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(8) Load Transient Response

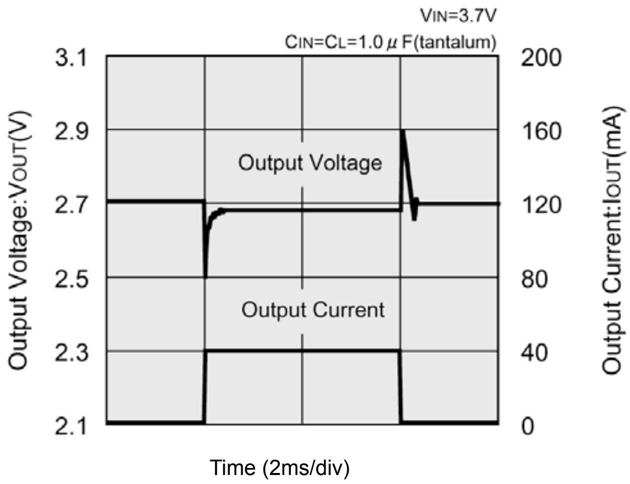
XC6201P132



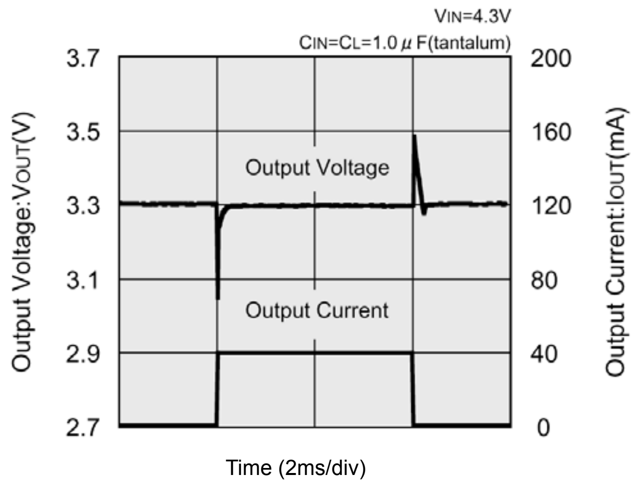
XC6201P182



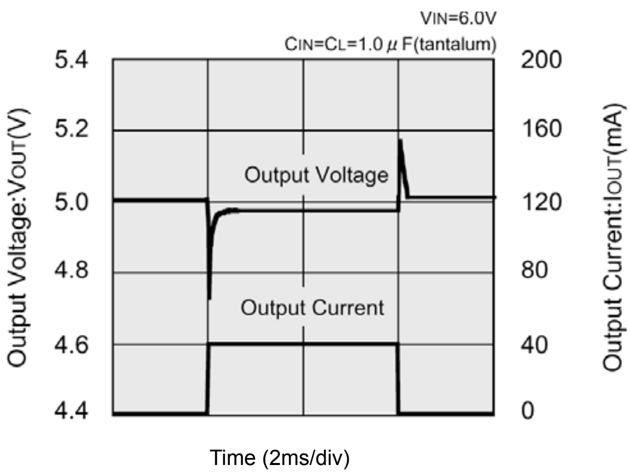
XC6201P272



XC6201P332



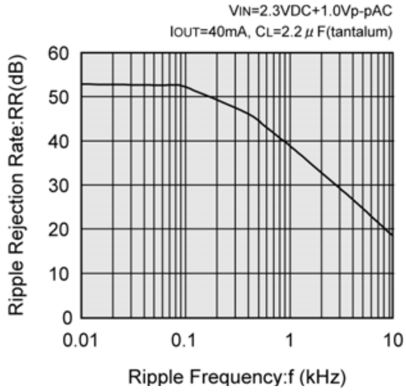
XC6201P502



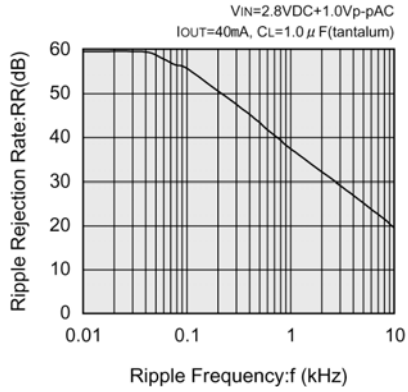
■TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(9) Ripple Rejection Rate

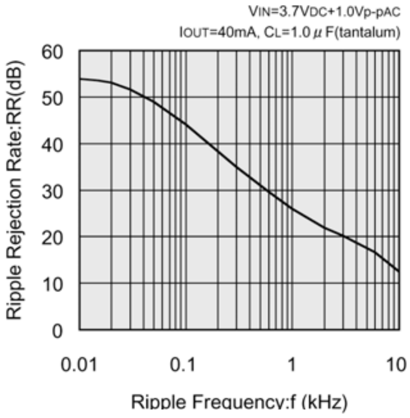
XC6201P132



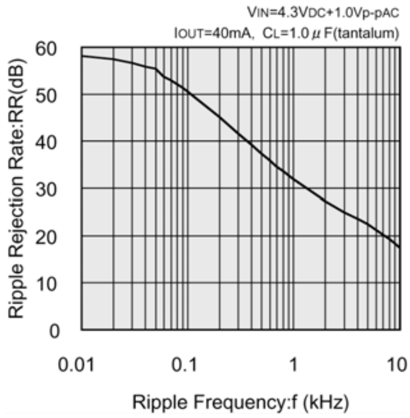
XC6201P182



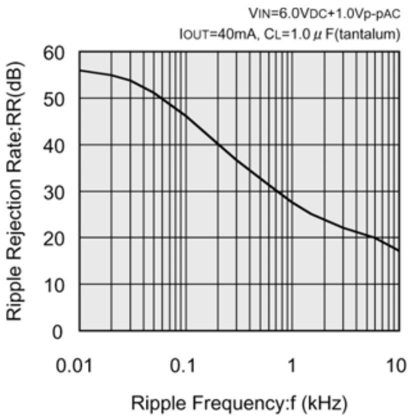
XC6201P272



XC6201P332

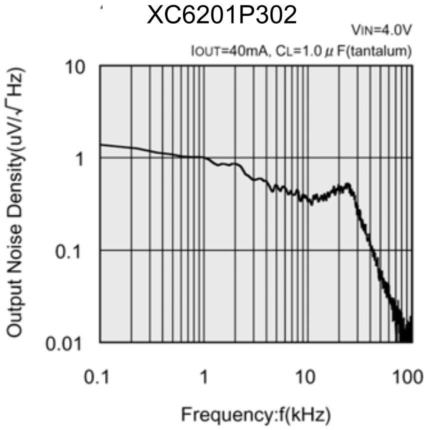


XC6201P502



(10) Output Noise Density

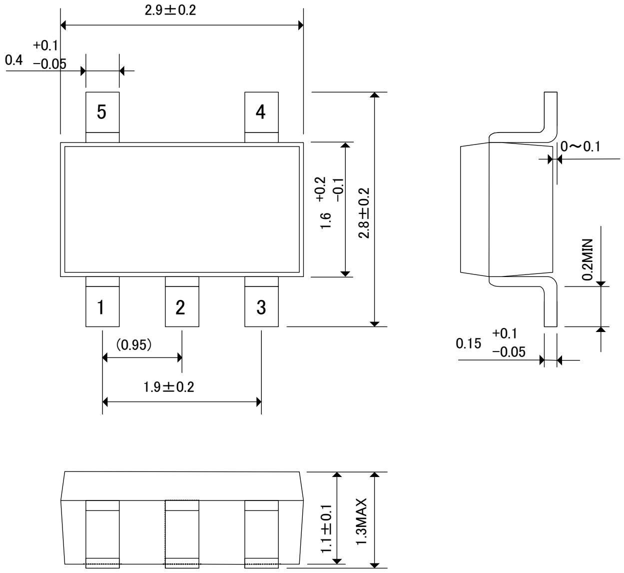
XC6201P302



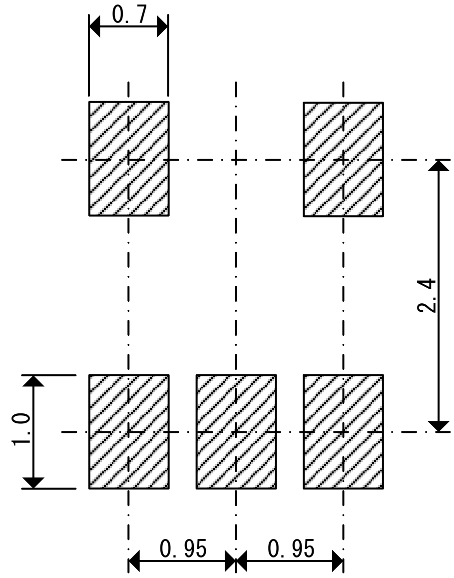
■PACKAGING INFORMATION

●SOT-25

Unit : mm

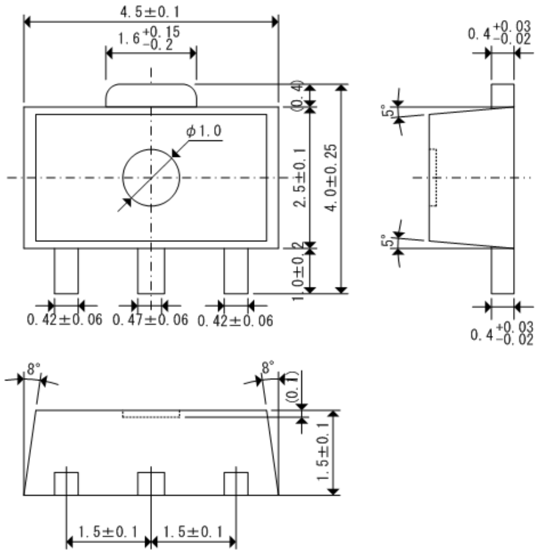


●SOT-25 Reference Pattern Layout

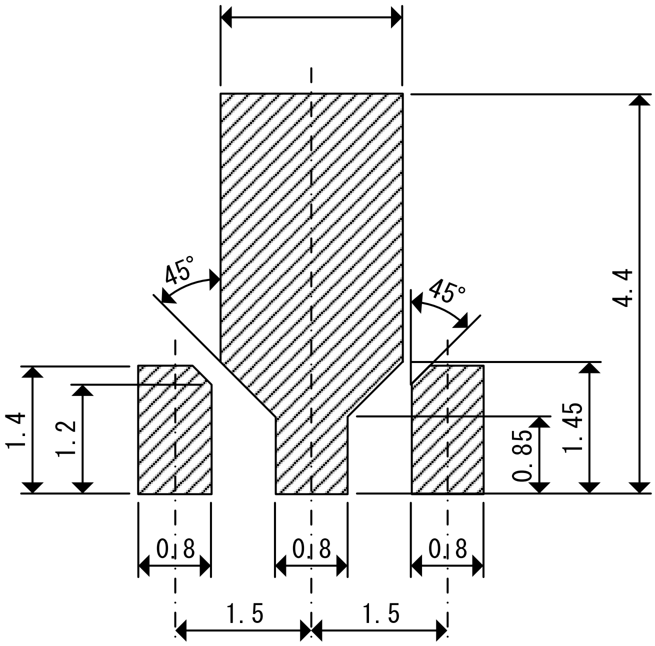


●SOT-89

Unit : mm



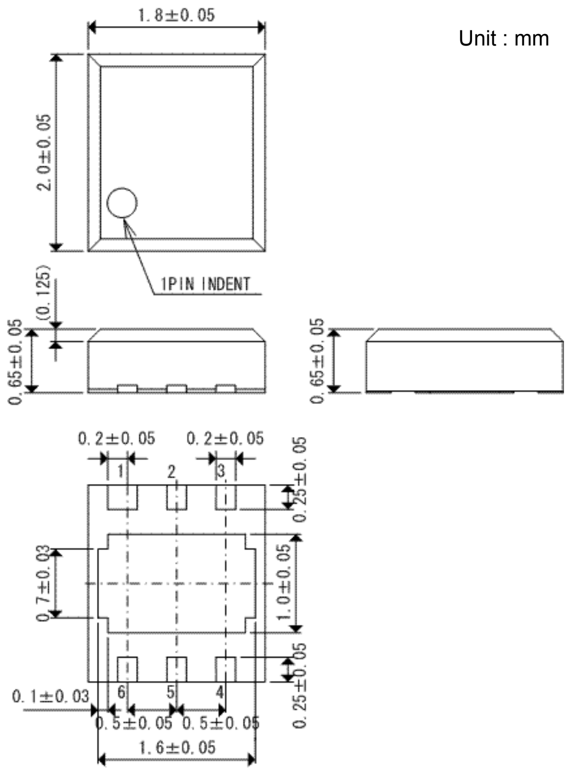
●SOT-89 Reference Pattern Layout



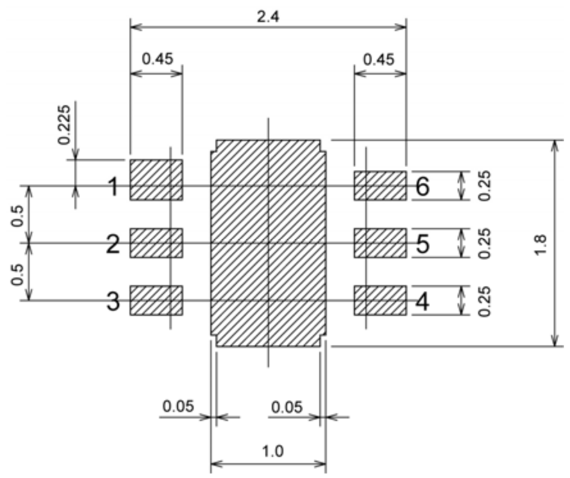
■PACKAGING INFORMATION (Continued)

●USP-6B

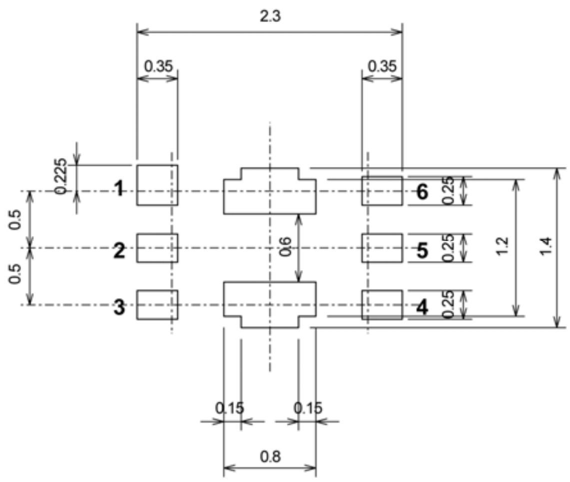
Unit : mm



●USP-6B Reference Pattern Layout



●USP-6B Reference Metal Mask Design

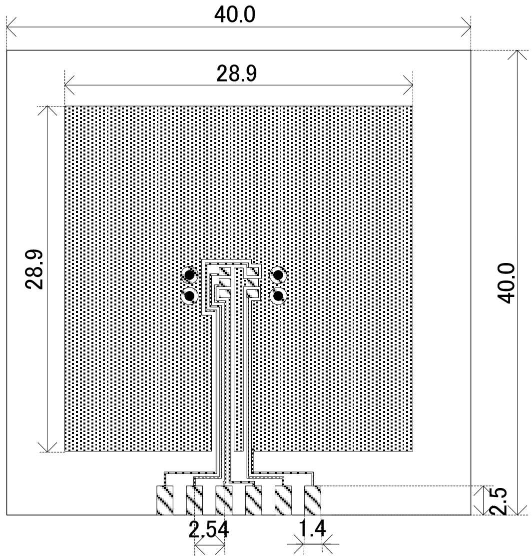


● SOT-25 Power Dissipation

Power dissipation data for the SOT-25 is shown in this page.
The value of power dissipation varies with the mount board conditions.
Please use this data as the reference data taken in the following condition.

1. Measurement Condition

Condition: Mount on a board
Ambient: Natural convection
Soldering: Lead (Pb) free
Board: Dimensions 40 x 40 mm
(1600 mm2 in one side)
Copper (Cu) traces occupy 50% of the board
area In top and back faces
Package heat-sink is tied to the copper traces
(Board of SOT-26 is used.)
Material: Glass Epoxy (FR-4)
Thickness: 1.6mm
Through-hole: 4 x 0.8 Diameter

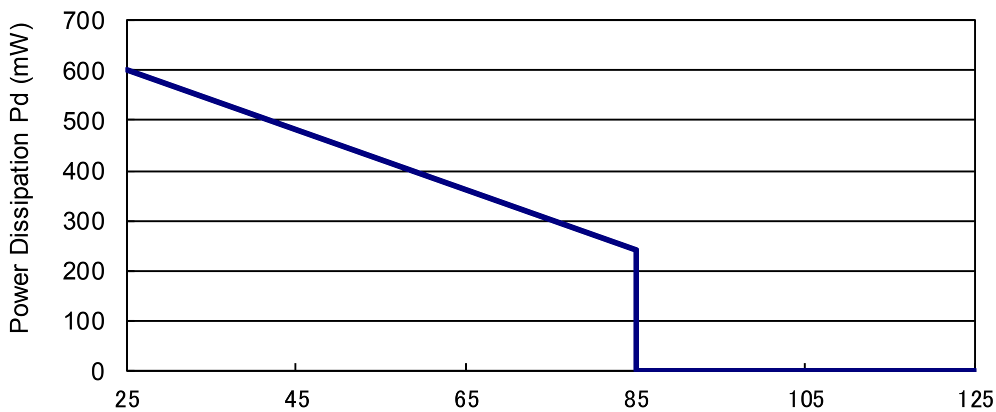


Evaluation Board (Unit: mm)

2.Power Dissipation vs. Ambient Temperature

Board Mount (Tj max = 125℃)

Ambient Temperature (℃)	Power Dissipation Pd (mW)	Thermal Resistance (℃/W)
25	600	166.67
85	240	

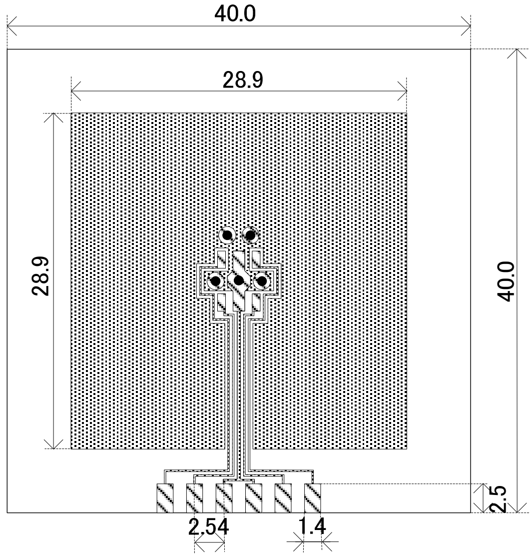


● SOT-89 Power Dissipation

Power dissipation data for the SOT-89 is shown in this page.
The value of power dissipation varies with the mount board conditions.
Please use this data as the reference data taken in the following condition.

1. Measurement Condition

Condition: Mount on a board
Ambient: Natural convection
Soldering: Lead (Pb) free
Board: Dimensions 40 x 40 mm
(1600 mm2 in one side)
Copper (Cu) traces occupy 50% of the board area In top and back faces
Package heat-sink is tied to the copper traces
Material: Glass Epoxy (FR-4)
Thickness: 1.6mm
Through-hole: 5 x 0.8 Diameter

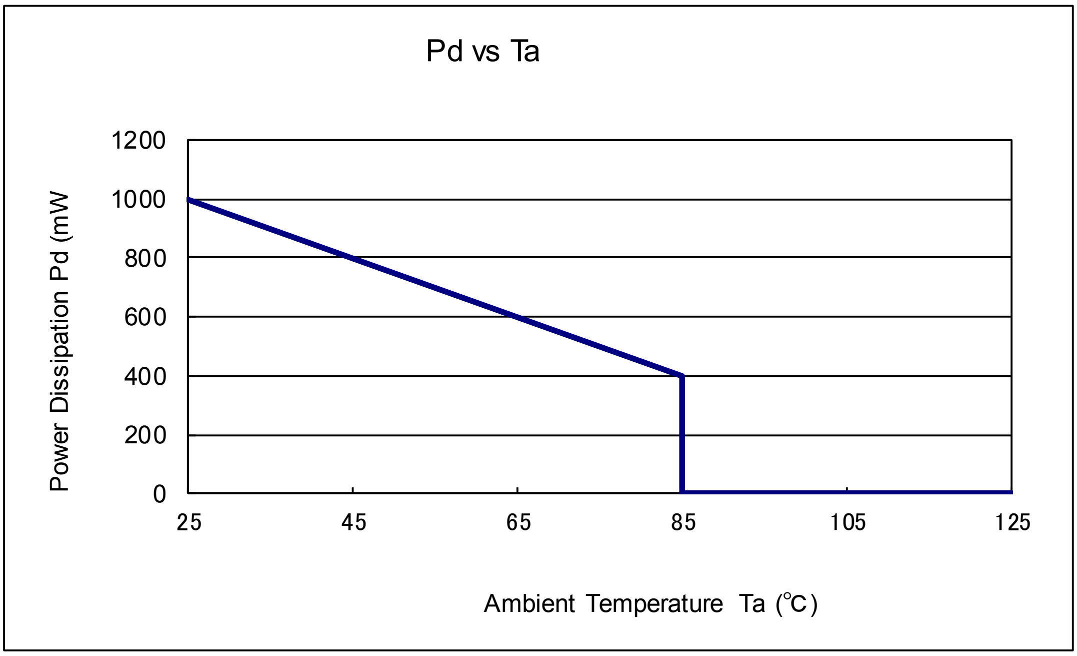


Evaluation Board (Unit : mm)

2.Power Dissipation vs. Ambient Temperature

Board Mount (Tj max = 125℃)

Ambient Temperature (℃)	Power Dissipation Pd (mW)	Thermal Resistance (℃/W)
25	1000	100.00
85	400	

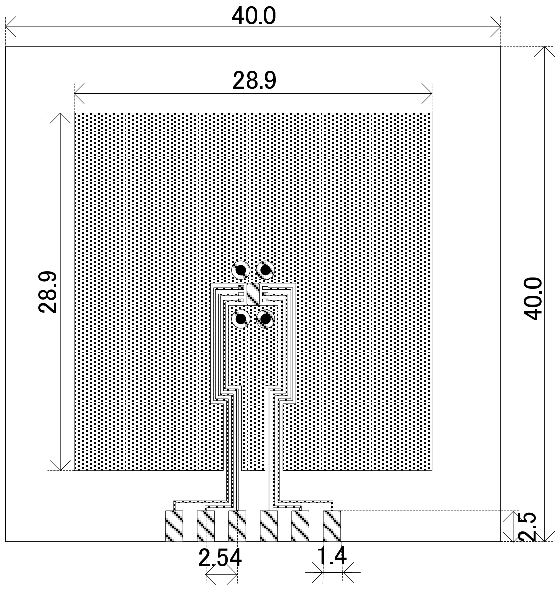


● USP-6B Power Dissipation

Power dissipation data for theUSP-6B is shown in this page.
The value of power dissipation varies with the mount board conditions.
Please use this data as the reference data taken in the following condition.

1. Measurement Condition

Condition: Mount on a board
Ambient: Natural convection
Soldering: Lead (Pb) free
Board: Dimensions 40 x 40 mm
(1600 mm2 in one side)
Copper (Cu) traces occupy 50% of the board
area In top and back faces
Package heat-sink is tied to the copper traces
Material: Glass Epoxy (FR-4)
Thickness: 1.6mm
Through-hole: 4 x 0.8 Diameter

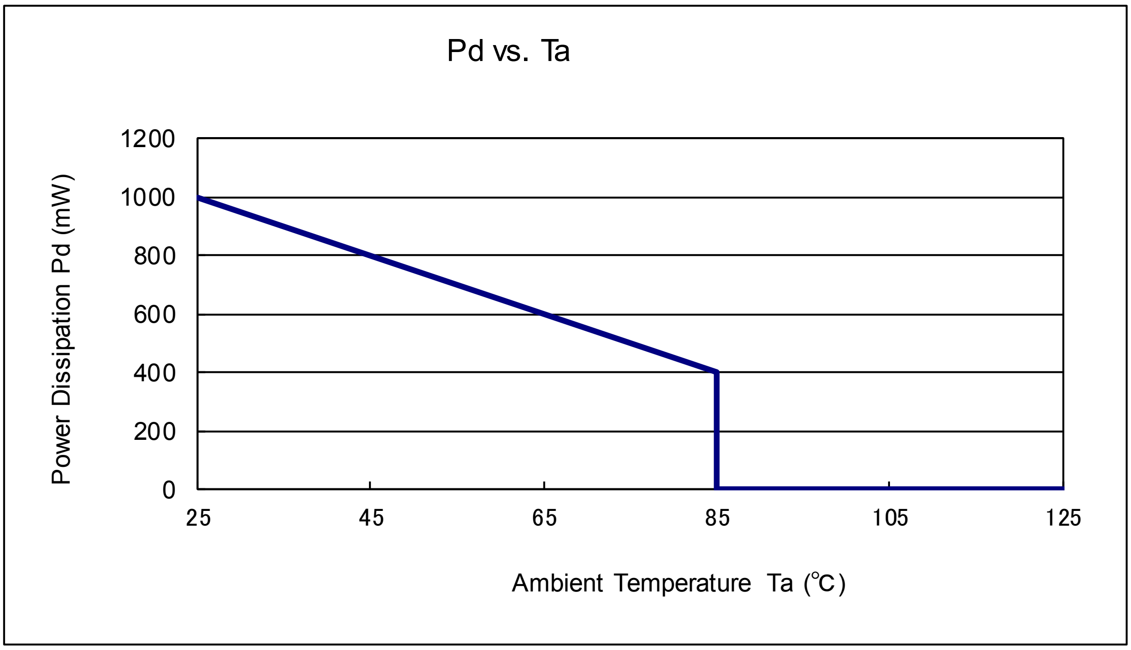


Evaluation Board (Unit: mm)

2.Power Dissipation vs. Ambient Temperature

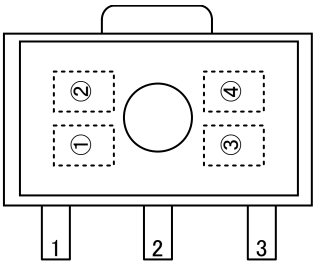
Board Mount (Tj max = 125℃)

Ambient Temperature (℃)	Power Dissipation Pd (mW)	Thermal Resistance (℃/W)
25	1000	100.00
85	400	

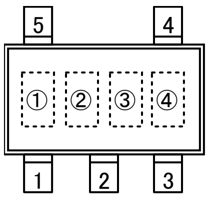


■MARKING RULE

●SOT-89, SOT-25



SOT-89
(TOP VIEW)



SOT-25
(TOP VIEW)

① represents the product series

MARK	PRODUCT SERIES
1	XC6201xxxxxx

② represents type of regulator

MARK		PRODUCT SERIES
Voltage= 0.1 ~ 3.0V	Voltage= 3.1 ~ 6.0V	
5	6	XC6201Pxxxxx
8	9	XC6201TxxxPx

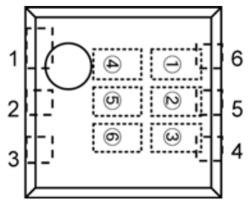
③ represents output voltage

MARK	OUTPUT VOLTAGE (V)			MARK	OUTPUT VOLTAGE (V)		
0	—	3.1	—	F	1.6	4.6	—
1	—	3.2	—	H	1.7	4.7	—
2	—	3.3	—	K	1.8	4.8	—
3	—	3.4	—	L	1.9	4.9	—
4	—	3.5	—	M	2.0	5.0	—
5	—	3.6	—	N	2.1	5.1	—
6	—	3.7	—	P	2.2	5.2	—
7	—	3.8	—	R	2.3	5.3	—
8	—	3.9	—	S	2.4	5.4	—
9	—	4.0	—	T	2.5	5.5	—
A	—	4.1	—	U	2.6	5.6	—
B	—	4.2	—	V	2.7	5.7	—
C	1.3	4.3	—	X	2.8	5.8	—
D	1.4	4.4	—	Y	2.9	5.9	—
E	1.5	4.5	—	Z	3.0	6.0	—

④ represents assembly lot number
0 to 9, A to Z repeated (G, I, J, O, Q, W excluded)

■MARKING RULE (Continued)

●USP-6B



USP-6B
(TOP VIEW)

①② represents product series

③ represents type of regulator

MARK	TYPE	PRODUCT SERIES
P	3pin Regulator	XC6201PxxxDx
T	V_{IN}=7V(Rated)	XC6201TxxxDx

④⑤ represents output voltage

MARK		VOLTAGE (V)	PRODUCT SERIES
④	⑤		
3	3	3.3	XC6201x33xDx
5	0	5.0	XC6201x50xDx

⑥ represents assembly lot number
0 to 9, A to Z repeated (G, I, J, O, Q, W excluded)
Note: No character inversion used.

1. The product and product specifications contained herein are subject to change without notice to improve performance characteristics. Consult us, or our representatives before use, to confirm that the information in this datasheet is up to date.

2. The information in this datasheet is intended to illustrate the operation and characteristics of our products. We neither make warranties or representations with respect to the accuracy or completeness of the information contained in this datasheet nor grant any license to any intellectual property rights of ours or any third party concerning with the information in this datasheet.

3. Applicable export control laws and regulations should be complied and the procedures required by such laws and regulations should also be followed, when the product or any information contained in this datasheet is exported.

4. The product is neither intended nor warranted for use in equipment of systems which require extremely high levels of quality and/or reliability and/or a malfunction or failure which may cause loss of human life, bodily injury, serious property damage including but not limited to devices or equipment used in 1) nuclear facilities, 2) aerospace industry, 3) medical facilities, 4) automobile industry and other transportation industry and 5) safety devices and safety equipment to control combustions and explosions. Do not use the product for the above use unless agreed by us in writing in advance.

5. Although we make continuous efforts to improve the quality and reliability of our products; nevertheless Semiconductors are likely to fail with a certain probability. So in order to prevent personal injury and/or property damage resulting from such failure, customers are required to incorporate adequate safety measures in their designs, such as system fail safes, redundancy and fire prevention features.

6. Our products are not designed to be Radiation-resistant.

7. Please use the product listed in this datasheet within the specified ranges.

8. We assume no responsibility for damage or loss due to abnormal use.

9.

TOREX SEMICONDUCTOR LTD.